



# AND180CRP-B

## GaAlAs Red Light Emission T-1 3/4 Package (5 mm)

#### **Features**

- Peak wavelength (λp = 660 nm) high bright emission
- · All plastic mold type, clear colorless lens
- Low drive current: 20 mA for outdoor applications
  0.5 mA for indoor applications
- Excellent On-Off contrast ratio
- Fast response time, capable of pulse operation
- Suitable for Outdoor Message Signboards

### Maximum Ratings $(T_a = 25^{\circ}C)$

Characteristics	Symbol Rating		Unit	
Forward Current	l <sub>F</sub>	Н0	mA	
Reverse Voltage	V <sub>R</sub>	5	٧	
Power Dissipation	$P_{D}$	Ϊ5	mW	
Operating Temperature Range	T <sub>Opr</sub>	-40 to 85	°C	
Storage Temperature Range	T <sub>Stg</sub>	-40 to 100	°C	

### Electro-Optical Characteristics ( $T_a = 25$ °C)

Characteristics	Symbol	Test Condition	Minimum	Typical	Maximum	Unit
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 20 mA	_	2.1	2.ĺ	V
Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 4 V	_	_	10	μΑ
Luminous Intensity	l <sub>V</sub>	I <sub>F</sub> = 20 mA	2,000	3,600	_	mcd
Peak Emission Wavelength	l <sub>P</sub>	I <sub>F</sub> = 20 mA	_	660	_	nm
Spectral Line Half Width	Δλ	I <sub>F</sub> = 20 mA	_	20	_	nm
Dominant Wavelength	λd	I <sub>F</sub> = 20 mA	_	640	_	nm
Full Viewing Angle	θ	I <sub>V</sub> = 1/2 Peak	_	12	_	degree

#### Precaution

Please be careful of the following:

- 1. Soldering temperature: 260°C max Soldering time: 5 sec. max
  - Soldering portion of lead: up to 1.6 mm from the body of the device
- 2. The lead can be formed up to 5 mm from the body of the device without forming stress. Soldering should be performed after the lead forming.

